



WSP-SME-515

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By: 2 P ~

Date: 3/26/02

IN THE UNITED STATES PATENT AND TRADEMARK OFFICE

Applicant : Jenoe Tihanyi  
Applic. No. : 10/007,397  
Filed : October 22, 2001  
Title : Semiconductor Component

RESPONSE TO NOTICE TO FILE MISSING PARTS AND  
SUPPLEMENTAL AMENDMENT

Hon. Commissioner of Patents and Trademarks,  
Washington, D. C. 20231

S i r :

Responsive to the Notice to File Missing Parts mailed on  
January 24, 2002, and supplemental to the preliminary  
amendment mailed on February 8, 2002, kindly amend the above-  
identified application in view of the following remarks:

In the Translated Specification:

Please add the abstract that is provided on a separate page  
together with this response.